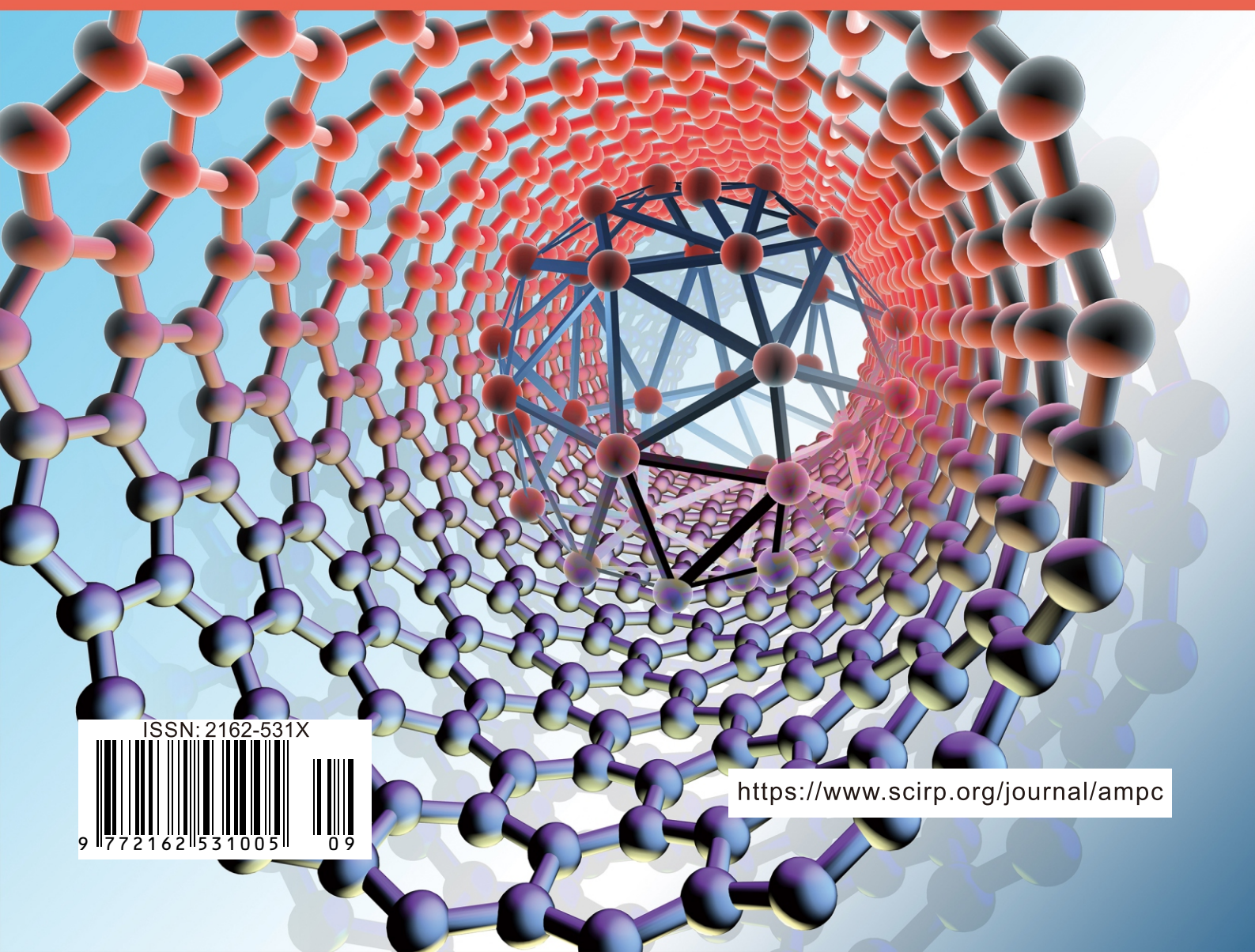


ISSN: 2162-531X

Volume 12, Number 9, September 2022



# Advances in Materials Physics and Chemistry



ISSN: 2162-531X



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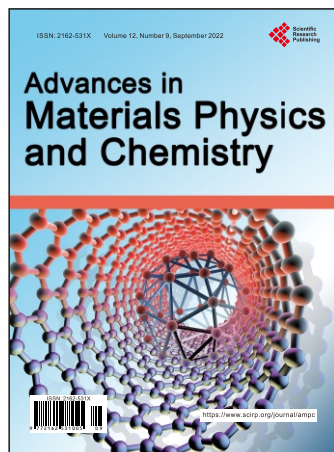
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